

DECLARATION

As a below named inventor, I declare that:

My residence, post office address and citizenship are as stated below next to my name; I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **SOLID PHASE SYNTHESIS OF LXR LIGANDS** the specification of which _____ is attached hereto or X was filed on April 4, 2001 as Application No. 09/827,837 and was amended on _____ (if applicable).

I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56. I claim foreign priority benefits under Title 35, United States Code, Section 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

Country	Application No.	Date of Filing	Priority Claimed Under 35 USC 119

I hereby claim the benefit under Title 35, United States Code § 119(e) of any United States provisional application(s) listed below:

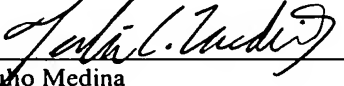
Application No.	Filing Date
60/194,911	04/05/00

I claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Application No.	Date of Filing	Status

Full Name of Inventor 1:	Last Name: MEDINA	First Name: JULIO	Middle Name or Initial:	
Residence & Citizenship:	City: San Carlos	State/Foreign Country: California	Country of Citizenship: United States	
Post Office Address:	Post Office Address: 1407 Cedar Street	City: San Carlos	State/Country: California	Postal Code: 94070
Full Name of Inventor 2:	Last Name: IMAZAKI	First Name: NAONORI	Middle Name or Initial:	
Residence & Citizenship:	City: Osaka	State/Foreign Country: Japan	Country of Citizenship: Japan	
Post Office Address:	Post Office Address: 118-22-902, Enoki-cho, Suita City	City: Osaka	State/Country: Japan	Postal Code: 564-0053

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Signature of Inventor 1	Signature of Inventor 2
	
Julio Medina	Naonori Imazaki
Date 6-15-01	Date

SF 1232930 v1

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Residence & Citizenship:	City: San Carlos	State/Foreign Country: California	Country of Citizenship: United States	
Post Office Address:	Post Office Address: 1407 Cedar Street	City: San Carlos	State/Country: California	Postal Code: 94070
Full Name of Inventor 2:	Last Name: IMAZAKI	First Name: NAONORI	Middle Name or Initial:	
Residence & Citizenship:	City: Osaka	State/Foreign Country: Japan	Country of Citizenship: Japan	
Post Office Address:	Post Office Address: 118-22-902, Enoki-cho, Suita City	City: Osaka	State/Country: Japan	Postal Code: 564-0053

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Signature of Inventor 1	Signature of Inventor 2
 Julio Medina	 <i>Naonori Imazaki</i> Naonori Imazaki
Date	Date <i>October 24th, 2001</i>

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